



(0.635 mm) .025"

QFS-RA SERIES

RIGHT-ANGLE GROUND PLANE SOCKET

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?QFS-RA

Insulator Material: Liquid Crystal Polymer Terminal & Ground Plane Material: Phosphor Bronze Plating: Au over 50 μ" (1.27 μm) Ni (Tin on Ground Plane Tail) Current Rating (-RA to -RA): Signal Contact: 4.1 A per pin (1 pin powered per row) Ground Plane: Testing Now! Voltage Rating: 300 VAC Operating Temp:

PROCESSING

Lead-Free Solderable:

-55 °C to +125 °C RoHS Compliant:

SMT Lead Coplanarity:

(0.10 mm) .004" max (026-052) (0.15 mm) .006" max (078)

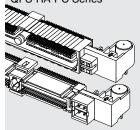
RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality

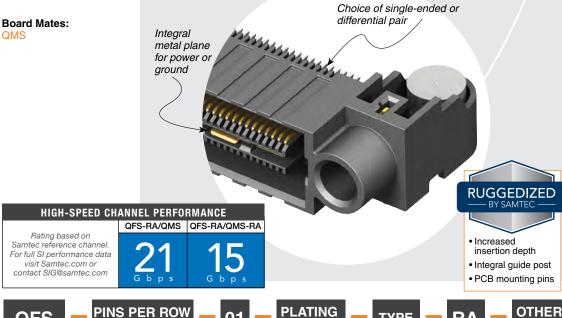


OTHER SOLUTIONS

Combination Signal/Power See QMS-RA-PC Series or QFS-RA-PC Series



Note: Some lengths, styles and options are non-standard, non-returnable.



PINS PER ROW PLATING OPTION NO. OF PAIRS

> -026, -052, -078(52 total pins per bank = -D) –016, *–*032, *–*048 (16 pairs per bank = -D-DP)

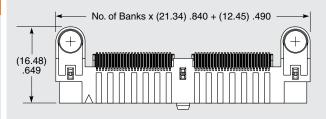
SL = 10 µ" (0.25 µm) Gold on Signal Pins and Ground Plane, Matte Tin on tails

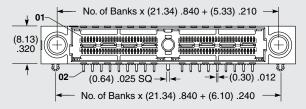
-D = Single-Ended -D-DP = Differential Pair

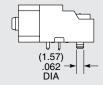
–K = Polyimide film Pick & Place Pad

OPTION

–TR = Tape & Reel (-016, -026, -032 & -052 positions only)







ALSO AVAILABLE (MOQ Required)

- · Other platings
- · Plastic Guide Post option
- –02 lead style for (2.36 mm) .093" thick board
- 64 (-DP) and 104 positions per row Contact Samtec.

I WWW.SAMTEC.COM